B/O FORM PTO Patent and Trade		2007 Commerce		
	FORM COVER!	HITA.0979		
To the Honorable	Commissioner of 103417			
1. Name of Co.	nveying Party(ies):	2. Name and Address of Receiving Party(ies):		
(1) TOMOYO (2) TARO O (3) HIDEAK (4) TAKESH	SABE, I KURATA, AND	Name: Renesas Technology Corp. Address: 4-1, Marunouchi 2-chome City: Chiyoda-ku, Tokyo, Japan		
Additional names of conveying parties attached: Yes No No Nature of Conveyance:				
⊠ Assignn	nent			
Execution Da	ate: (1)(2)(3) August 3, 2004; (4) August 5, 2004			
4. (a) Patent Application Number(s):				
If this document is being filed together with a new application, the execution date of the application is: Additional Numbers Attached.		4. (b) Patent Numbers: 11/808228		
5. Name and Address of Party to whom Correspondence Concerning this Document Should be Mailed:		6. Total Number of Applications and Patents Involved: 1		
Name:	Stanley P. Fisher	7. Total Fee: \$40.00 (37 C.F.R. § 3.41)		
Address:	Reed Smith LLP 3110 Fairview Park Dr. Suite 1400 Falls Church, VA 22042	Enclosed. Authorized to be charged to deposit account.		
	,	8. Deposit Account Number: 08-1480		
DO NOT USE T	THIS CDACE	ATTACH DUPLICATE COPY OF THIS PAGE IF PAYING BY DEPOSIT ACCOUNT		
9. Statement and Signature:				
To the best of my knowledge and belief, the foregoing is true and correct and any attached copy is a true copy of the original doodment.				
June 7, 2007				
Stanley P. Fisher	r, Registration No. 24, 344	Juan Carlos A. Marquez, Registration No. 34,072		
Total number of pages comprising cover sheet: 1				

96/98/2007 SZEWDIE1 90900024 11808228 94 FC:8021 / 40.00 OP

PATENT REEL: 019452 FRAME: 0143

ASSIGNMENT (譲 渡 証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Renesas Technology Corp.

a corporation organized under the laws of Japan,

located at 4-1, Marunouchi 2-chome, Chiyoda-ku, Tokyo, Japan

receipt of which is hereby acknowledged I do hereby sell and assign to said Renesas Technology Corp. its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

SEMICONDUCTOR MEMORY DEVICE AND METHOD FOR PRODUCING THE SAME

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted,

to be held and enjoyed by said Renesas Technology Corp.

its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Renesas Technology Corp.

Signed on the date(s) indicated aside our signatures:

RECORDED: 06/07/2007

	INVENTOR(S) (発明者フルネームサイン)	Date Signed (署名日)
1)	Jong Li Ali'	8/3/2004
2)_	Jano Orlus	8/3/2004
3)	Htdeaki hurata	8/3/2004
4)	Takeshi Sakata	8/5/2004
5)_		
6)_		
7)_	·	
8)_		
9)		
10)		

PATENT REEL: 019452 FRAME: 0144